

3.3V CMOS 16-BIT *IDT74LVCH162244A* BUFFER/DRIVER WITH 3-STATE OUTPUTS, 5 VOLT TOLERANT I/O, AND BUS-HOLD

FEATURES:

- Typical tSK(o) (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- VCC = 3.3V ± 0.3V, Normal Range
- Vcc = 2.7V to 3.6V, Extended Range
- CMOS power levels (0.4µ W typ. static)
- · All inputs, outputs, and I/O are 5V tolerant
- Available in TSSOP package

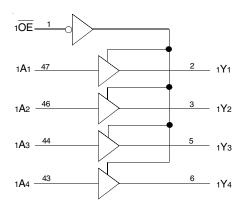
DRIVE FEATURES:

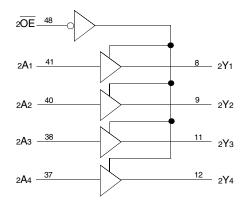
- Balanced Output Drivers: ±12mA
- · Full internal series termination

APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- · Data communication and telecommunication systems

FUNCTIONAL BLOCK DIAGRAM





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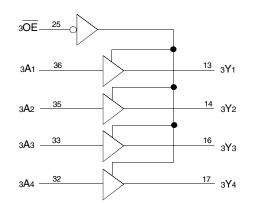
DESCRIPTION:

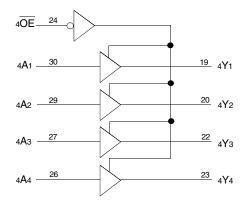
The LVCH162244A 16-bit buffer/driver is built using advanced dual metal CMOS technology. The LVCH162244A is designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The device can be used as four 4-bit buffers, two 8-bit buffers, or one 16-bit buffer. This device provides true outputs and symmetrical active-low output-enable $\overline{(OE)}$ inputs.

All pins of this 16-bit buffer/driver can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

The LVCH162244A has series resistors in the device output structure which will significantly reduce line noise when used with light loads. This driver has been developed to drive ± 12 mA at the designated threshold levels.

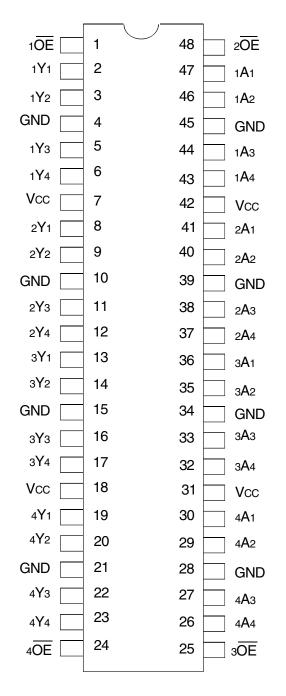
The LVCH162244A has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistors.





3.3V CMOS 16-BIT BUFFER/DRIVER WITH 3-STATE OUTPUTS

PIN CONFIGURATION



TSSOP TOP VIEW

INDUSTRIAL TEMPERATURE RANG

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM	Terminal Voltage with Respect to GND	-0.5 to +6.5	V
Tstg	Storage Temperature	–65 to +150	°C
Ιουτ	DC Output Current	–50 to +50	mA
Ік Іок	Continuous Clamp Current, Vı < 0 or Vo < 0	-50	mA
lcc Iss	Continuous Current through each Vcc or GND	±100	mA

NOTE:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Parameter ⁽¹⁾	Conditions	Тур.	Max.	Unit
Input Capacitance	VIN = 0V	4.5	6	pF
Output Capacitance	Vout = 0V	6.5	8	рF
I/O Port Capacitance	VIN = 0V	6.5	8	pF
	Input Capacitance Output Capacitance	Input CapacitanceVIN = 0VOutput CapacitanceVOUT = 0V	Input CapacitanceVIN = 0V4.5Output CapacitanceVOUT = 0V6.5	Input CapacitanceVIN = 0V4.56Output CapacitanceVOUT = 0V6.58

1. As applicable to the device type.

PIN DESCRIPTION

Description	
3-State Output Enable Inputs (Active LOW)	
Data Inputs ⁽¹⁾	
3-State Outputs	

NOTE:

1. These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE (EACH 4-BIT BUFFER)⁽¹⁾

Inp	Outputs	
×ŌĒ	хАх	xYx
L	L	L
L	Н	Н
Н	Х	Z

NOTE:

1. H = HIGH Voltage Level

X = Don't Care

L = LOW Voltage Level

Z = High-Impedance

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: $T_A = -40^{\circ}C$ to +85°C

Symbol	Parameter	Tes	t Conditions	Min.	Typ. ⁽¹⁾	Max.	Unit
Vih	Input HIGH Voltage Level	Vcc = 2.3V to 2.7V		1.7	_	_	V
		Vcc = 2.7V to 3.6V		2	—	_	
VIL	Input LOW Voltage Level	Vcc = 2.3V to 2.7V			_	0.7	V
		Vcc = 2.7V to 3.6V		_	—	0.8	
Ін	Input Leakage Current	Vcc = 3.6V	VI = 0 to 5.5V	-	-	±5	μA
lıL							
lozн	High Impedance Output Current	Vcc = 3.6V	Vo = 0 to 5.5V	_	-	±10	μA
Iozl	(3-State Output pins)						
loff	Input/Output Power Off Leakage	Vcc = 0V, VIN or Vo \leq 5.	5V	_	_	±50	μA
Vik	Clamp Diode Voltage	Vcc = 2.3V, IIN = -18mA		-	-0.7	-1.2	V
Vн	Input Hysteresis	Vcc = 3.3V			100	_	mV
ICCL ICCH	Quiescent Power Supply Current	Vcc = 3.6V	VIN = GND or Vcc	-	-	10	μA
lccz			$3.6 \le VIN \le 5.5V^{(2)}$	<u> </u>	_	10	
ΔICC	Quiescent Power Supply Current Variation	One input at Vcc - 0.6V, o	One input at Vcc - 0.6V, other inputs at Vcc or GND		-	500	μA

NOTES:

1. Typical values are at Vcc = 3.3V, +25°C ambient.

2. This applies in the disabled state only.

BUS-HOLD CHARACTERISTICS

Symbol	Parameter ⁽¹⁾	Test Conditions		Min.	Typ. ⁽²⁾	Max.	Unit
Івнн	Bus-Hold Input Sustain Current	Vcc = 3V	VI = 2V	-75	—	_	μA
IBHL			VI = 0.8V	75	—	—	
Івнн	Bus-Hold Input Sustain Current	Vcc = 2.3V	VI = 1.7V	_	—	_	μA
IBHL			VI = 0.7V	—	_	—	
Івнно	Bus-Hold Input Overdrive Current	Vcc = 3.6V	VI = 0 to 3.6V	_	_	±500	μA
Ibhlo							

NOTES:

1. Pins with Bus-Hold are identified in the pin description.

2. Typical values are at Vcc = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Con	ditions ⁽¹⁾	Min.	Max.	Unit
Vон	Output HIGH Voltage	Vcc = 2.3V to 3.6V	Iон = - 0.1mA	Vcc-0.2	_	V
		Vcc = 2.3V	Iон = - 4mA	1.9	_	
			Iон = - 6mA	1.7	_	
		Vcc = 2.7V	Iон = - 4mA	2.2	_	
			Iон = - 8mA	2	_	
		Vcc = 3V	Iон = - 6mA	2.4	_	
			Іон = – 12mA	2	_	
Vol	Output LOW Voltage	Vcc = 2.3V to 3.6V	IoL = 0.1mA	—	0.2	V
		Vcc = 2.3V	IoL = 4mA	—	0.4	
			IOL = 6mA	_	0.55	
		Vcc = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	—	0.6	
		Vcc = 3V	IOL = 6mA	—	0.55	
			IoL = 12mA	_	0.8	Ĩ

NOTE:

1. VIH and VIL must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate Vcc range. TA = − 40°C to + 85°C.

OPERATING CHARACTERISTICS, TA = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
Cpd	Power Dissipation Capacitance per Buffer/Driver Outputs enabled	C∟ = 0pF, f = 10Mhz	35	pF
Cpd	Power Dissipation Capacitance per Buffer/Driver Outputs disabled		4	

SWITCHING CHARACTERISTICS⁽¹⁾

		Vcc =	= 2.7V	Vcc = 3.3	V ± 0.3V	
Symbol	Parameter	Min.	Max.	Min.	Max.	Unit
tPLH	Propagation Delay	—	5.6	1.1	4.4	ns
t PHL	xAx to xYx					
tрzн	Output Enable Time	—	6.9	1	5.5	ns
tPZL	xOE to xYx					
tPHZ	Output Disable Time	—	6.8	1.8	6.3	ns
tPLZ	xOE to xYx					
tsk(o)	Output Skew ⁽²⁾	—	—	—	500	ps

NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. TA = -40° C to + 85° C.

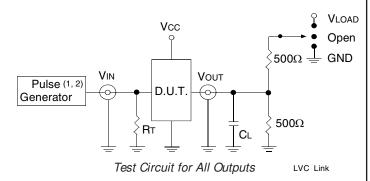
2. Skew between any two outputs of the same package and switching in the same direction.

DT74LVCH162244A

INDUSTRIAL TEMPERATURE RANGE

TEST CIRCUITS AND WAVEFORMS TEST CONDITIONS

Symbol	Vcc ⁽¹⁾ =3.3V±0.3V	Vcc ⁽¹⁾ =2.7V	Vcc ⁽²⁾ =2.5V±0.2V	Unit
VLOAD	6	6	2 x Vcc	V
Vih	2.7	2.7	Vcc	V
Vт	1.5	1.5	Vcc/2	V
Vlz	300	300	150	mV
Vнz	300	300	150	mV
CL	50	50	30	рF



DEFINITIONS:

CL = Load capacitance: includes jig and probe capacitance.

 $\mathsf{R} \mathsf{T}$ = Termination resistance: should be equal to $\mathsf{Z} \mathsf{O} \mathsf{U} \mathsf{T}$ of the Pulse Generator.

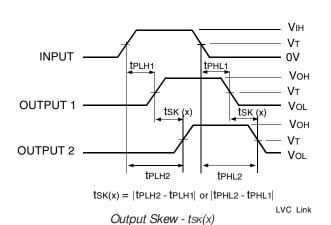
NOTES:

1. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2.5ns; tR \leq 2.5ns.

2. Pulse Generator for All Pulses: Rate \leq 10MHz; tF \leq 2ns; tR \leq 2ns.

SWITCH POSITION

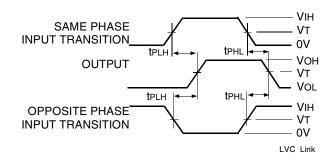
Test	Switch
Open Drain Disable Low Enable Low	Vload
Disable High Enable High	GND
All Other Tests	Open



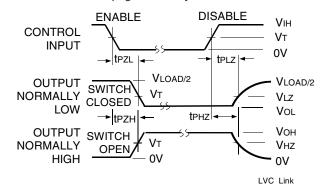
NOTES:

1. For tsk(o) OUTPUT1 and OUTPUT2 are any two outputs.

2. For tsk(b) OUTPUT1 and OUTPUT2 are in the same bank.



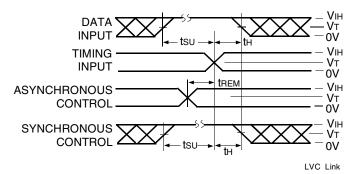
Propagation Delay

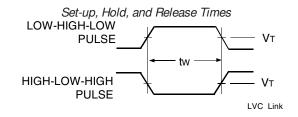


Enable and Disable Times

NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

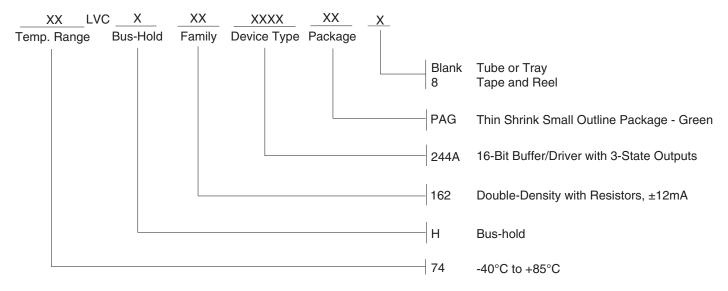




Pulse Width

IDT74LVCH162244A 3.3V CMOS 16-BIT BUFFER/DRIVER WITH:

ORDERINGINFORMATION



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